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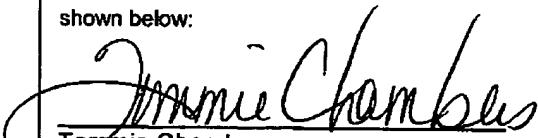
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NAME OF INVENTOR(S): Sheperek	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/736,661	
TITLE OF INVENTION: TEMPERATURE COMPENSATION SYSTEMS AND METHODS FOR USE WITH READ/WRITE HEADS IN MAGNETIC STORAGE DEVICES	
FILE NO.: DEPOSIT ACCT. NO.: TI-36723 20-0668	
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